



BSI Standards Publication

Surface mounting technology

Part 3: Standard method for the specification of components
for through-hole reflow (THR) soldering

National foreword

This British Standard is the UK implementation of EN IEC 61760-3:2021. It is identical to IEC 61760-3:2021. It supersedes BS EN 61760-3:2010, which will be withdrawn on 1 October 2021.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its committee manager.

This publication does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

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Amendments/corrigenda issued since publication

Date	Text affected
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